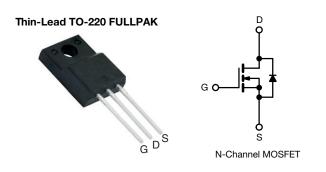
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Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.220			
Q _g max. (nC)	71				
Q _{gs} (nC)	10				
Q _{gd} (nC)	21				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 Fullpack
Lead (Pb)-free and halogen-free	SIHA21N80AEF-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage			V _{DS}	800	-	
Gate-source voltage			V _{GS}	± 30	V	
Continuous drain current ($T_J = 150 \ ^\circ C$) $^\circ$	V at 10 V	T _C = 25 °C	- I _D	7.0		
	V _{GS} at 10 V	T _C = 100 °C		4.4	А	
Pulsed drain current ^a	ent ^a		I _{DM}	37	1	
Linear derating factor			0.26	W/°C		
Single pulse avalanche energy ^b		E _{AS}	32	mJ		
Maximum power dissipation			PD	33	W	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C		
Drain-source voltage slope		T _J = 125 °C	100		N//	
Reverse diode dv/dt ^d		dv/dt	50	V/ns		
Soldering recommendations (peak temperature) ^c		For 10 s		260	°C	
Mounting torque	M3 screw		-	0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 1.5 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 170 A/µs, starting T_J = 25 °C

e. Limited by maximum junction temperature

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COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP. MAX.			UNIT			
Maximum junction-to-ambient	R _{thJA}	- 65			0 0 4 M			
Maximum junction-to-case (drain)	R _{thJC}	- 3.8				°C/W		
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μΑ	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.8	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	2.0	-	4.0	V
		$V_{GS} = \pm 20 V$			-	-	± 100	nA
Gate-source leakage	I _{GSS}	V _{GS} = ± 30 V			-	-	± 1	μA
		V _{DS} = 640 V, V _{GS} = 0 V			-	-	1	μA
Zero gate voltage drain current	IDSS	V _{DS} = 640 V	, V _{GS} = 0 V	′, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	١ _c	₀ = 8.5 A	-	0.220	0.250	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 30 V, I _D =	= 11 A	-	8.7	-	S
Dynamic						•		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1511	-	pF	
Output capacitance	C _{oss}			-	58	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	44	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	271	-		
Total gate charge	Qg				-	47	71	
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 11 A, V _{DS} = 640 V		A, V _{DS} = 640 V	-	10	-	nC
Gate-drain charge	Q _{gd}				-	21	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 640 V, I _D = 11 A,		-	18	36		
Rise time	t _r			-	28	56		
Turn-off delay time	t _{d(off)}		$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	44	88	ns
Fall time	t _f	1		-	43	86		
Gate input resistance	R _g	f = 1 MHz, open drain		0.2	0.5	1.0	Ω	
Drain-Source Body Diode Characterist		•						
Continuous source-drain diode current	IS	MOSFET symbol showing the integral reverse p - n junction diode		-	-	7.0	A	
Pulsed diode forward current	I _{SM}			-	-	37		
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 11 \text{ A},$ di/dt = 100 A/µs, V _R = 400 V		- 1	128	256	ns	
Reverse recovery charge	Q _{rr}			-	0.8	1.6	μC	
Reverse recovery current	I _{RRM}			-	12	-	A	

Notes

f. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 480 V

g. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 V to 480 V



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

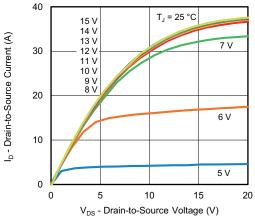


Fig. 1 - Typical Output Characteristics

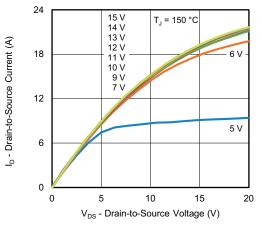


Fig. 2 - Typical Output Characteristics

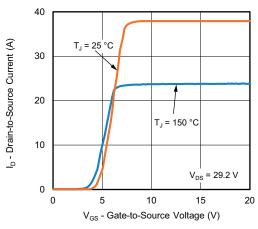


Fig. 3 - Typical Transfer Characteristics

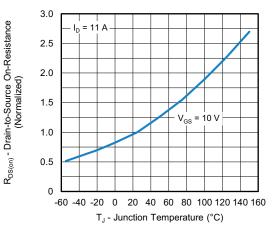


Fig. 4 - Normalized On-Resistance vs. Temperature

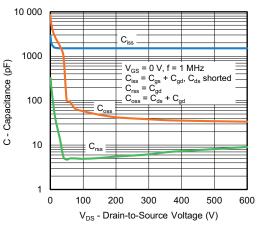
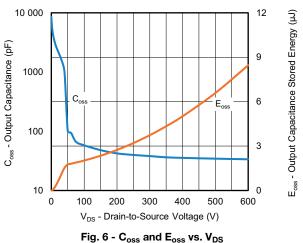


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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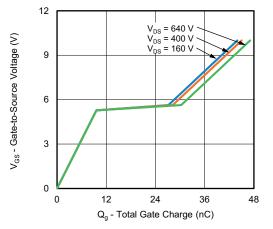


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

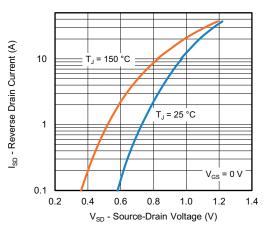


Fig. 8 - Typical Source-Drain Diode Forward Voltage

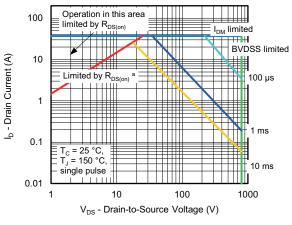
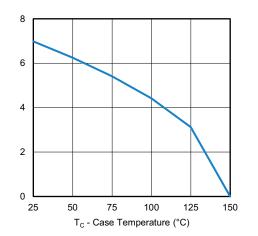


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



l_D - Drain Current (A)

Fig. 10 - Maximum Drain Current vs. Case Temperature

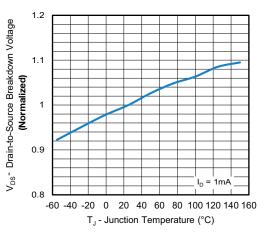


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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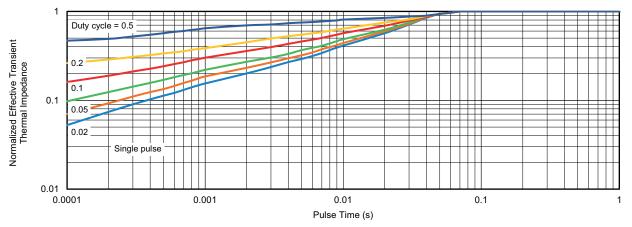


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

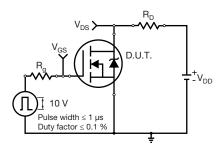


Fig. 13 - Switching Time Test Circuit

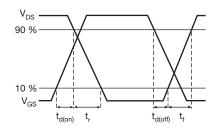


Fig. 14 - Switching Time Waveforms

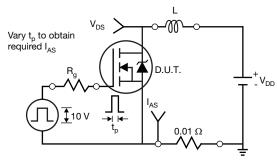


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

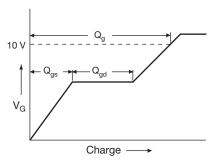


Fig. 17 - Basic Gate Charge Waveform

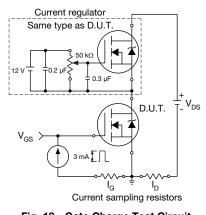


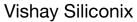
Fig. 18 - Gate Charge Test Circuit

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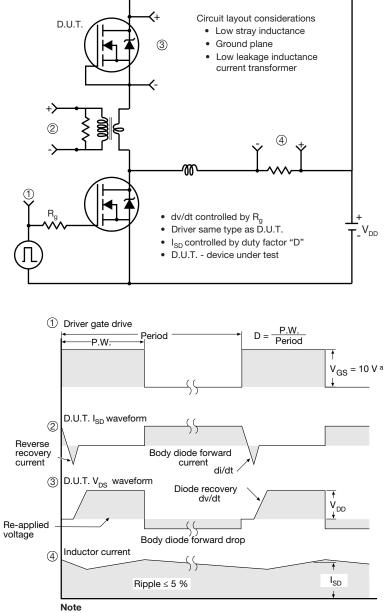
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Peak Diode Recovery dv/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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